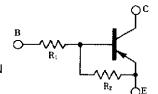


on-chip resistor PNP silicon epitaxial transistor For mid-speed switching

FEATURES

• On-chip bias resistor (R₁ = 4.7 k Ω , R₂ = 10 k Ω)



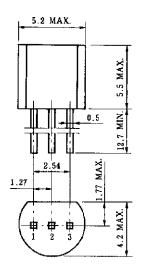
· Complementary transistor with AA1L3N

ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	Vcво	-60	V
Collector to emitter voltage	VCEO	–50	V
Emitter to base voltage	VEBO	- 5	V
Collector current (DC)	Ic(DC)	-100	mA
Collector current (Pulse)	Ic(pulse) *	-200	mA
Total power dissipation	Рт	250	mW
Junction temperature	Tj	150	°C
Storage temperature	T _{stg}	-55 to +150	°C

^{*} PW \leq 10 ms, duty cycle \leq 50 %

PACKAGE DRAWING (UNIT: mm)



Electrode Connection

1. Emitter EIAJ : SC -43B
2. Collector JEDEC : TO −92
3. Base IEC : PA33

ELECTRICAL CHARACTERISTICS (Ta = 25°C)

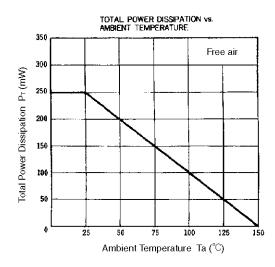
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector cutoff current	Ісво	Vcb = -50 V, IE = 0			-100	nA
DC current gain	h _{FE1} **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -5.0 \text{ mA}$	35	60	100	-
DC current gain	h _{FE2} **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -50 \text{ mA}$	80	200		-
Collector saturation voltage	VCE(sat) **	Ic = -5.0 mA, IB = -0.25 mA		-0.04	-0.2	V
Low level input voltage	VIL **	$V_{CE} = -5.0 \text{ V}, \text{ Ic} = -100 \ \mu\text{A}$		-0.9	-0.6	V
High level input voltage	V _{IH} **	$V_{CE} = -0.2 \text{ V}, \text{ Ic} = -5.0 \text{ mA}$	-3.0	-1.5		V
Input resistance	R ₁		3.29	4.7	6.11	kΩ
E-to-B resistance	R ₂		7	10	13	kΩ
Turn-on time	ton	$Vcc = -5 \text{ V}, \text{ R}_L = 1 \text{ k}\Omega$			0.2	μs
Storage time	t stg	V _I = -5 V, PW = 2 μs			5.0	μs
Turn-off time	toff	duty cycle≤2 %			6.0	μs

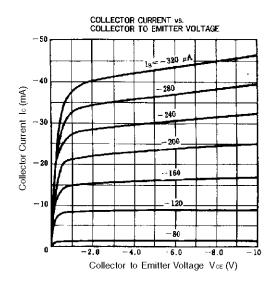
^{**} PW \leq 350 μ s, duty cycle \leq 2 %

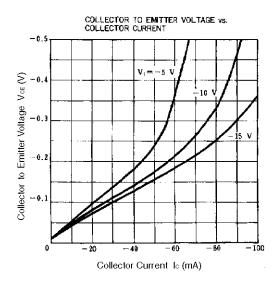
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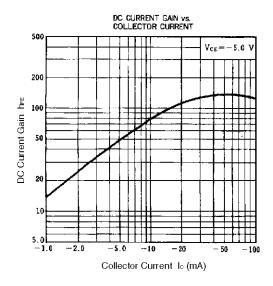


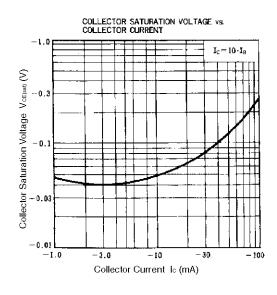
TYPICAL CHARACTERISTICS (Ta = 25°C)

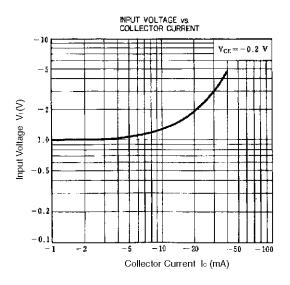


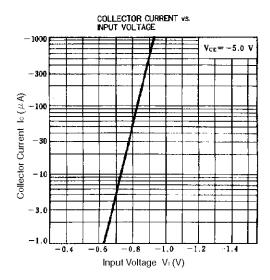


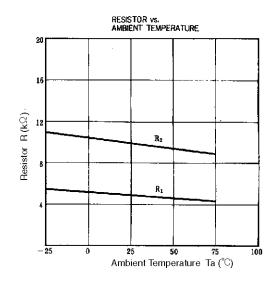












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